

PROTECTION PRODUCTS

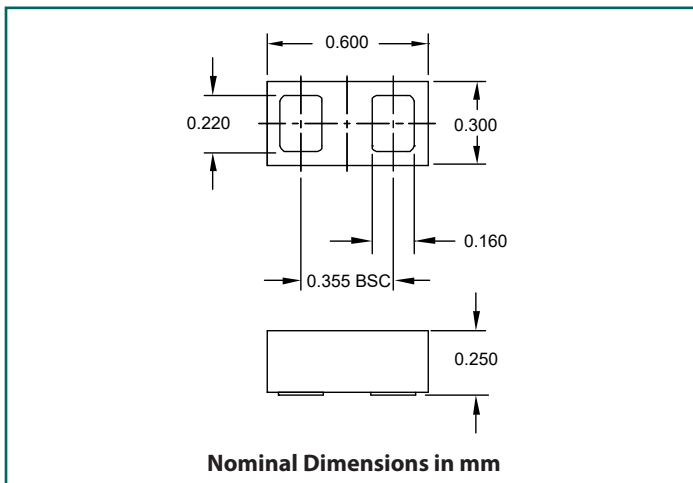
Description

RClamp®3371ZC is an ultra low capacitance “FemtoClamp™” ESD protection device specifically designed to protect high-speed differential lines. It offers desirable characteristics for board level protection including fast response time, low operating and clamping voltage, and no device degradation.

RClamp3371ZC features extremely good ESD protection characteristics highlighted by low peak ESD clamping voltage, and high ESD withstand voltage (+/-10kV contact per IEC 61000-4-2). RClamp3371ZC has a maximum capacitance of 0.25pF allowing it to be used on Thunderbolt and USB 3.1 high speed lines. These devices may also be used for EOS protection due to their high peak pulse current capability (9A, $t_p = 8/20\mu s$). Each device will protect one high-speed data line operating up to 3.3 volts.

RClamp3371ZC is in a 2-pin SLP0603P2X3J package measuring 0.60 x 0.30 mm with a nominal height of only 0.25mm. Leads are finished with NiAu. The small package gives the designer the flexibility to protect single lines in applications where arrays are not practical.

Nominal Dimensions



Features

- ESD and EOS Protection
- ESD withstand voltage
 - ♦ IEC 61000-4-2 (ESD) $\pm 17kV$ (air), $\pm 10kV$ (contact)
- IEC 61000-4-4 (EFT) 40A (5/50ns)
- Ultra-Low capacitance: 0.25pF Maximum
- Very small PCB area
- Protects one high-speed data line
- Working voltage: 3.3V
- Low reverse leakage current: 50nA max at $V_R = 3.3V$
- Large operating bandwidth: 13.5GHz
- Solid-state silicon-avalanche technology

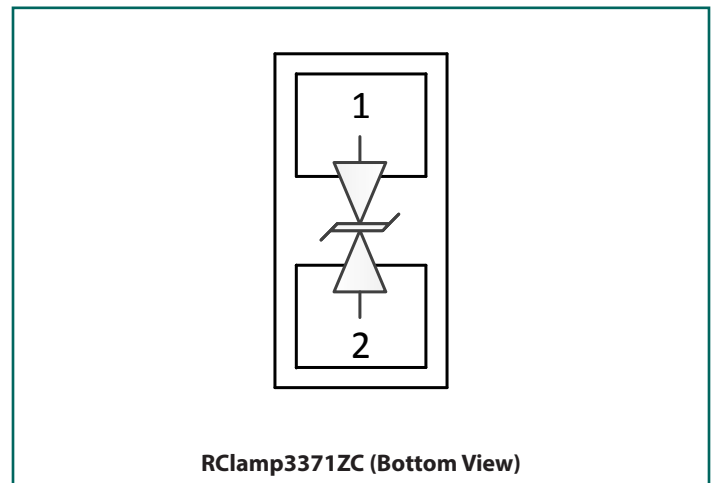
Mechanical Characteristics

- SLP0603P2X3J Package
- Pb-Free, Halogen Free, RoHS/WEEE Compliant
- Nominal Dimensions: 0.60 x 0.30 x 0.25 mm
- Lead Finish: NiAu
- Marking : Marking Code
- Packaging : Tape and Reel

Applications

- USB 3.1 and USB 3.0
- HDMI 1.4 and HDMI 2.0
- USB Type-C
- Thunderbolt
- HD-SDI
- 10GbE
- 6G/12G-SDI

Schematic and Pin Configuration



Absolute Maximum Ratings

Rating	Symbol	Value	Units
Peak Pulse Power (tp = 8/20μs)	P _{PK}	65	W
Peak Pulse Current (tp = 8/20μs)	I _{PP}	9	A
ESD per IEC 61000-4-2 (Air) ⁽¹⁾ ESD per IEC 61000-4-2 (Contact) ⁽¹⁾	V _{ESD}	±17 ±10	kV
Operating Temperature	T _{OP}	-40 to +85	°C
Storage Temperature	T _{STG}	-55 to +150	°C

Electrical Characteristics (T=25°C unless otherwise specified)

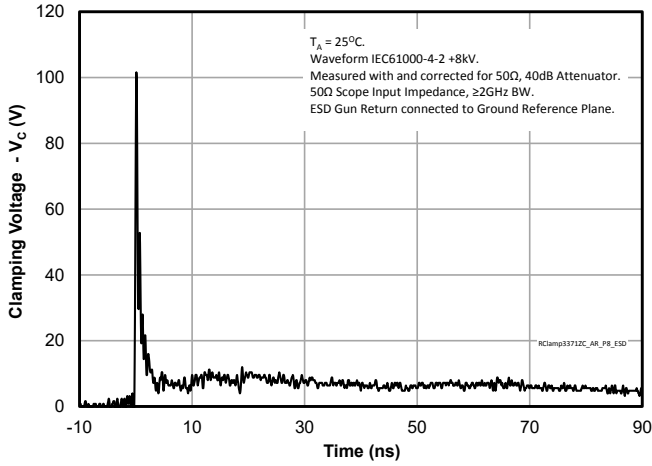
Parameter	Symbol	Conditions	Min.	Typ.	Max.	Units
Reverse Stand-Off Voltage	V _{RWM}	-40°C to 85°C			3.3	V
Reverse Breakdown Voltage	V _{BR}	I _t = 1mA -40°C to 85°C	5.5	8	10	V
Reverse Leakage Current	I _R	V _{RWM} = 3.3V	T = 25°C	<5	50	nA
			T = 85°C	<5	150	
Clamping Voltage ²	V _C	I _{PP} = 9A, tp = 1.2/50μs (Voltage), 8/20μs (Current) Combination Waveform, R _S = 2 Ω		5.4	7	V
ESD Clamping Voltage ³	V _C	I _{PP} = 4A, tp = 0.2/100ns (TLP)		3		V
ESD Clamping Voltage ³	V _C	I _{PP} = 16A, tp = 0.2/100ns (TLP)		4.6		
Dynamic Resistance ^{3,4}	R _{DYN}	tp = 0.2/100ns (TLP)		0.14		Ohms
Junction Capacitance	C _J	V _R = 0V, f = 1MHz T = 25°C		0.23	0.25	pF
Cutoff Frequency	F _C	-3dB		13.5		GHz

Notes:

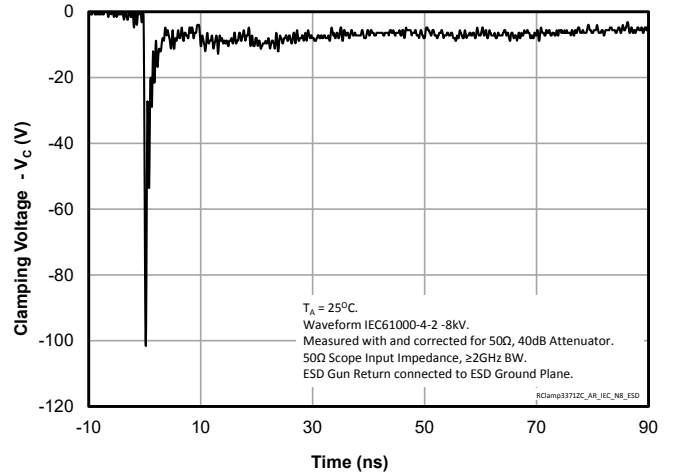
- (1): ESD gun return path connected to Ground Reference Plane (GRP).
- (2): Measured using a 1.2/50μs voltage, 8/20μs current combination waveform, R_S = 2 Ohms. Clamping is defined as the peak voltage across the device after the device snaps back to a conducting state.
- (3): Transmission Line Pulse Test (TLP) Settings: tp = 100ns, tr = 0.2ns, I_{TLP} and V_{TLP} averaging window: t₁ = 70ns to t₂ = 90ns.
- (4): Dynamic resistance calculated from I_{TLP} = 4A to I_{TLP} = 16A

Typical Characteristics

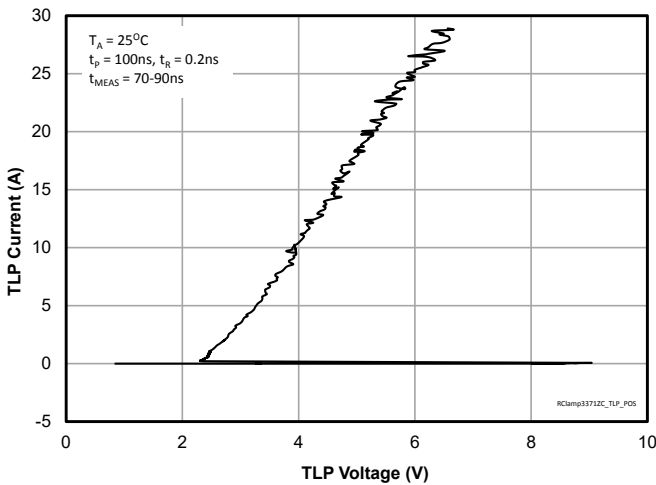
ESD Clamping (+8kV Contact per IEC 61000-4-2)



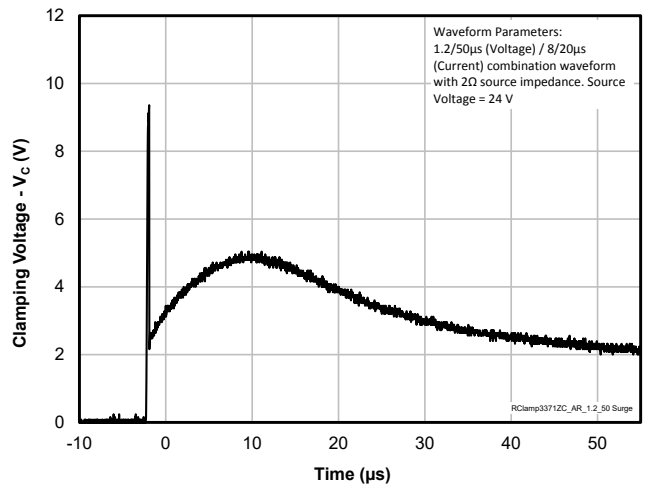
ESD Clamping (-8kV Contact per IEC 61000-4-2)



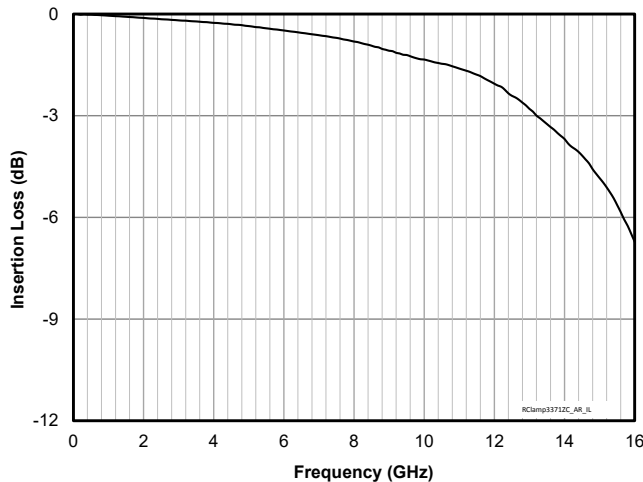
TLP IV Curve



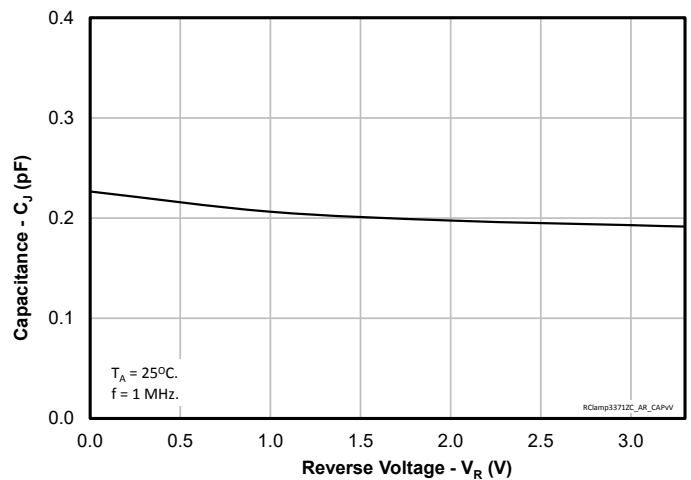
Clamping Characteristic (1.2/50 μs Waveform)



Insertion Loss (S21)

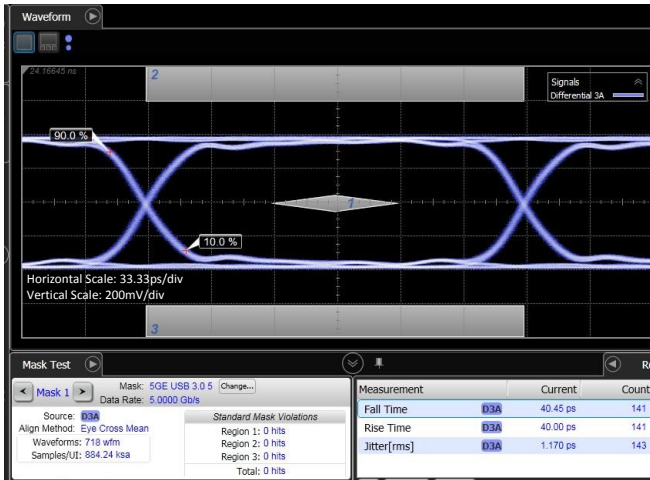


Capacitance vs. Reverse Voltage



Typical Characteristics (Continued)

5Gb/s (USB 3.0) Eye Diagram with RClamp3371ZC



5Gb/s (USB 3.0) Eye Diagram without RClamp3371ZC



10Gb/s (USB 3.1) Eye Diagram with RClamp3371ZC



10Gb/s (USB 3.1) Eye Diagram without RClamp3371ZC



Application Information

USB Type-C Interface Protection

USB Type-C is a 12-pin connector which supports USB 3.1 Gen 2 SuperSpeed+ (10Gb/s) connections and USB power delivery (USB PD). It is also backwards compatible (via an adapter) with USB 3.0 and USB 2.0. The USB Type-C connector does not imply the use of USB 3.1 technology. USB Type-C is a connector shape. The underlying technology may be USB 2.0, USB 3.0, or USB 3.1. USB Type-C plugs are reversible (i.e. can be either be inserted right-side up or upside-down position) so there are connections on both the top and bottom of the PCB. The USB Type-C receptacle consists of 24-pins including: SuperSpeed RX and TX signal pairs, USB 2.0 DP and DM data pins, Auxiliary pins, Configuration pins, and Power and Ground Pins. Any of these connections are capable of conducting ESD current and should be protected.

Protection Solutions

SuperSpeed data line pairs are located on both the top and bottom of the PCB to support Type-C plug reversal (i.e. flip-ability). ESD protection of the SuperSpeed line pairs is achieved using one RClamp3371ZC between each line and ground. The low capacitance of RClamp3371ZC (0.25pF maximum) exhibits minimal effect on the transmission line impedance and excellent insertion loss characteristics. Single line devices make it easier for the designer to route the traces and maintain equal distance between the differential pairs for maximum signal integrity.

RClamp3371ZC features very good ESD characteristics highlighted by low holding voltage after snapback, and extremely low dynamic resistance ($R_{DYN} = 0.14 \Omega$). Besides the SuperSpeed+ lines, USB 2.0 pins support Type-C plug reversal by shorting together the D+ pins and D- pins in the plug receptacle. This means RClamp3371ZC only needs to be placed on the side of the PCB where the traces are routed. RClamp3371ZC can also be used to protect the configuration channel (CC) and Sideband (SBU) pins. VBUS pins are connected together within the Type-C plug and bussed together on the PCB. USB Type-C default power is fixed at 5V. Single line power protection devices such as PClamp0501P are recommended for surge and ESD protection. Note that in power delivery (PD) applications, higher working voltage TVS devices may be needed.

Examples of USB Type-C ESD protection topology RClamp3371ZC and PClamp0501P are shown in Figures 1 and 2.

Device Placement

Placement of the protection component is a critical element for effective ESD suppression. TVS should be placed as close to the connector as possible. This helps to reduce transient coupling to nearby traces. Ground connections should be made directly to the ground plane using micro-vias. This reduces parasitic inductance in the ground path and minimizes the clamping voltage seen by the protected device.

Figure 1 - USB Type-C Top Layer Protection Example

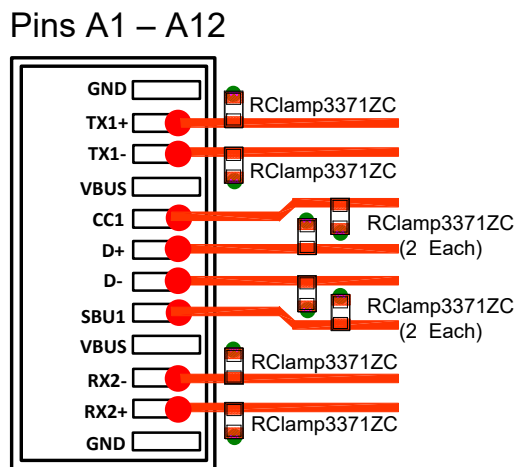
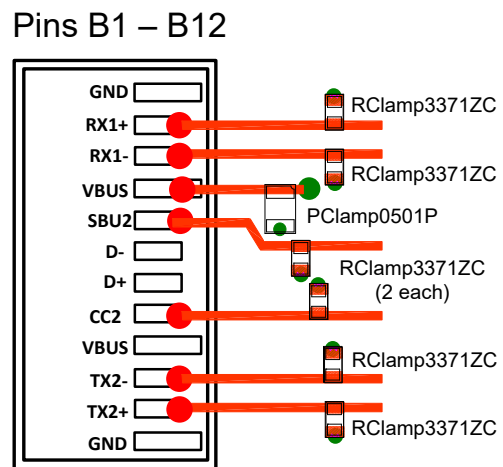


Figure 2 - USB Type-C Bottom Layer Protection Example



Application Information

Assembly Guidelines

The small size of this device means that some care must be taken during the mounting process to insure reliable solder joints. The figure at the right details Semtech's recommended mounting pattern. Recommended assembly guidelines are shown in Table 1. Note that these are only recommendations and should serve only as a starting point for design since there are many factors that affect the assembly process. Exact manufacturing parameters will require some experimentation to get the desired solder application.

Solder Stencil

Stencil design is one of the key factors which will determine the volume of solder paste which is deposited onto the land pad. The area ratio of the stencil aperture will determine how well the stencil will print. The area ratio takes into account the aperture shape, aperture size, and stencil thickness. A minimum area ratio of 0.66 is preferred for the subject package. The area ratio of a rectangular aperture is given as:

$$\text{Area Ratio} = (L * W) / (2 * (L + W) * T)$$

Where:

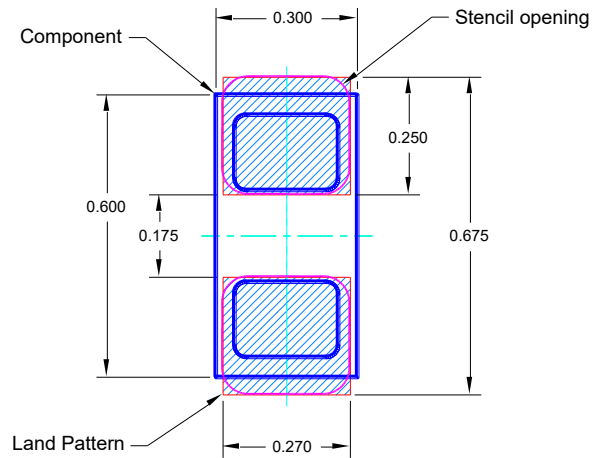
L = Aperture Length

W = Aperture Width

T = Stencil Thickness

Semtech recommends a stencil with square aperture and rounded corners for consistent solder release. The stencil should be laser cut with electro-polished finish. A stencil thickness of 0.075mm (0.003") is recommended. A 0.100mm (0.004") stencil may be used, however the stencil opening may need to be increased slightly to achieve the desired area ratio to ensure proper solder coverage on the pad.

Recommended Mounting Pattern



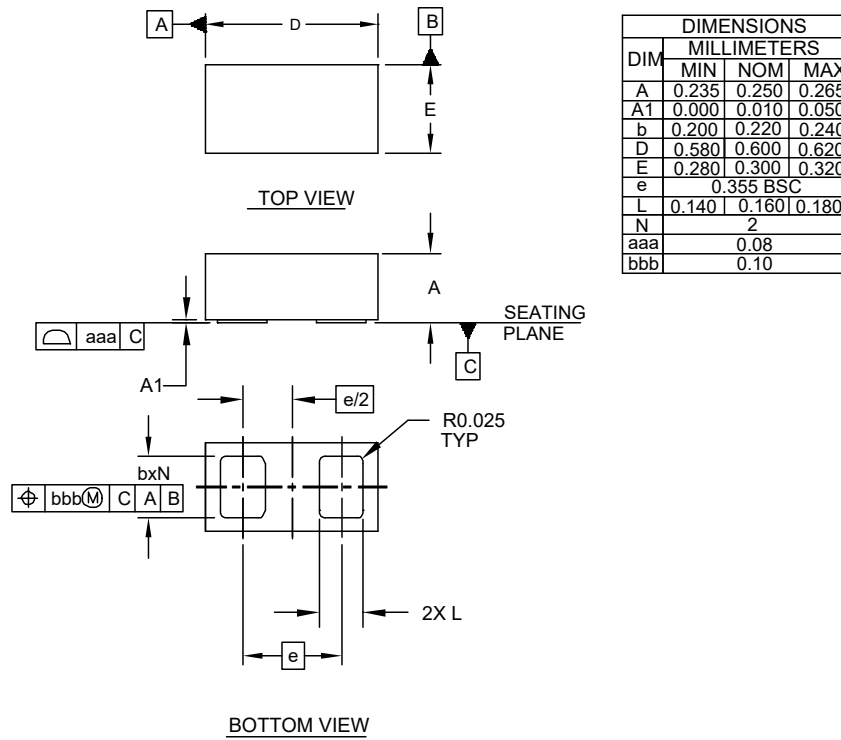
All Dimensions are in mm.

 Land Pad.  Stencil opening  Component

Table 1 - Assembly Guidelines

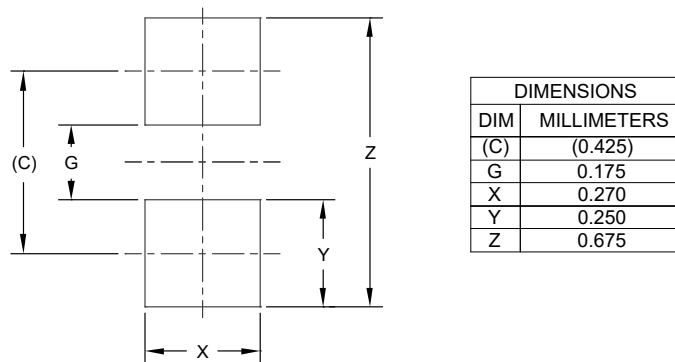
Assembly Parameter	Recommendation
Solder Stencil Design	Laser Cut, Electro-Polished
Aperture Shape	Rectangular with Rounded Corners
Solder Stencil Thickness	0.075mm (0.003") or 0.100mm (0.004")
Solder Paste Type	Type 4 Size Sphere or Smaller
Solder Reflow Profile	Per JEDEC J-STD-020
PCB Solder Pad Design	Solder Mask Defined or Non Solder Mask Defined
PCB Pad Finish	OSP or NiAu

Outline Drawing - SLP0603P2X3J



NOTES:
1. CONTROLLING DIMENSIONS ARE IN MILLIMETERS (ANGLES IN DEGREES).

Land Pattern - SLP0603P2X3J



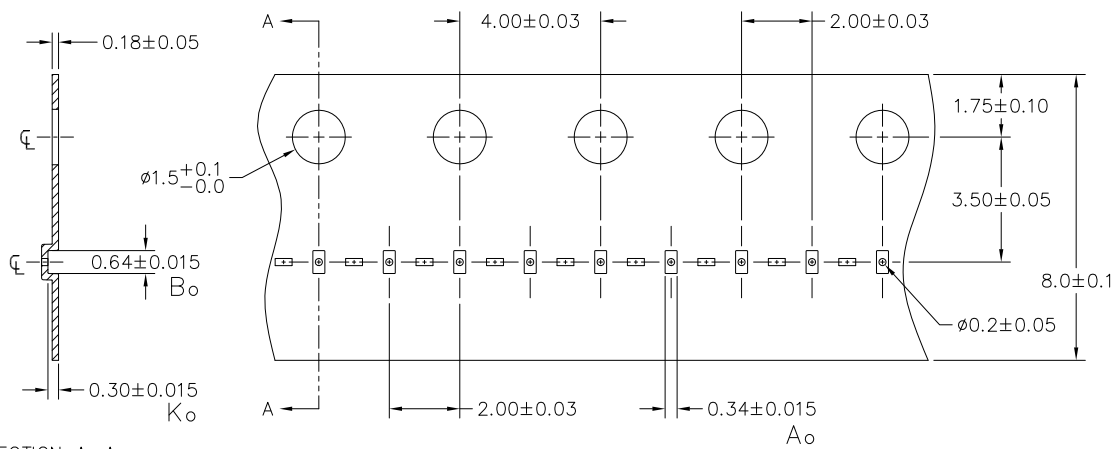
NOTES:
1. CONTROLLING DIMENSIONS ARE IN MILLIMETERS (ANGLES IN DEGREES).
2. THIS LAND PATTERN IS FOR REFERENCE PURPOSES ONLY.
CONSULT YOUR MANUFACTURING GROUP TO ENSURE YOUR COMPANY'S MANUFACTURING GUIDELINES ARE MET.

Marking Code

7C

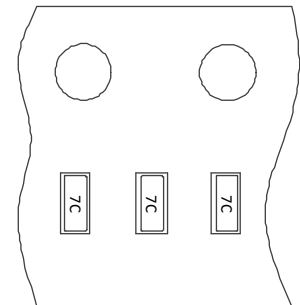
Notes: Device is electrically symmetrical.

Plastic Tape and Reel Specification

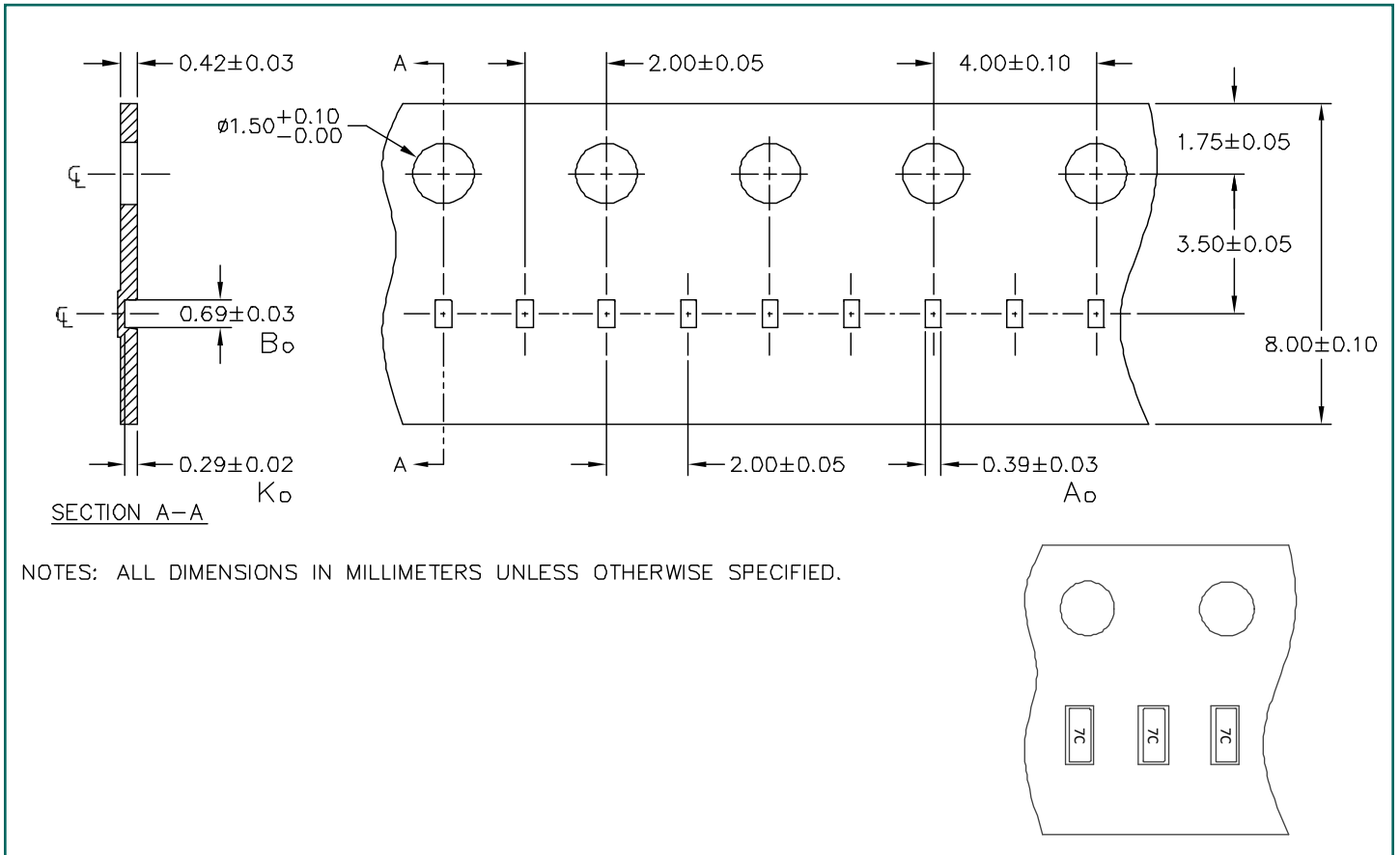


SECTION A-A

NOTE: ALL DIMENSIONS IN MILLIMETERS UNLESS OTHERWISE SPECIFIED.



Paper Tape and Reel Specification



Ordering Information

Part Number	Tape Material	Qty per Reel	Reel Size
RClamp3371ZCNT	Plastic	10000	7 Inch
RClamp3371ZCFT	Paper	15000	7 Inch

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